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Vishay Siliconix

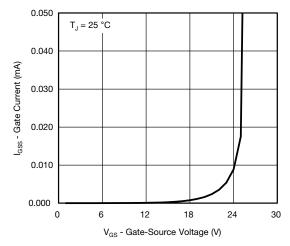
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					L	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	30	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	-5.2	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 20	μΑ
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$	ï	-	± 1	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	5	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A	-	0.0040	0.0048	Ω
		V _{GS} = 4.5 V, I _D = 18 A	1	0.0051	0.0062	
Forward transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	-	80	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	1515	-	pF
Output capacitance	C _{oss}		-	322	-	
Reverse transfer capacitance	C _{rss}		-	175	-	
Total mate charge	Q_g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	1	29	45	nC
Total gate charge		V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 20 A	-	14	21	
Gate-source charge	Q _{gs}		-	4.5	-	
Gate-drain charge	Q _{gd}		-	4.2	-	
Gate resistance	R _g	f = 1 MHz	0.2	1.2	2.4	Ω
Turn-on delay time	t _{d(on)}	$V_{DD} = 15 \text{ V, } R_L = 1.5 \Omega$ $I_D \cong 10 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_g = 1 \Omega$	-	20	30	ns
Rise time	t _r		-	125	190	
Turn-off delay time	t _{d(off)}		-	24	40	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$ $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	1	10	20	
Rise time	t _r		-	16	24	
Turn-off delay time	t _{d(off)}		-	25	40	
Fall time	t _f		1	3	8	
Drain-Source Body Diode Characteristic	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	50	А
Pulse diode forward current (t = 100 μs)	I _{SM}		-	-	200	
Body diode voltage	V_{SD}	I _S = 10 A, V _{GS} = 0 V	-	0.8	1.2	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C	-	20	40	ns
Body diode reverse recovery charge	Q _{rr}		-	10	20	nC
Reverse recovery fall time	ta		-	8	-	ns
Reverse recovery rise time	t _b		_	12	-	

Notes

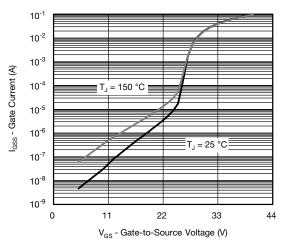
- a. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

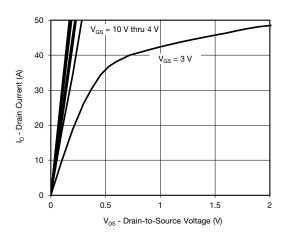




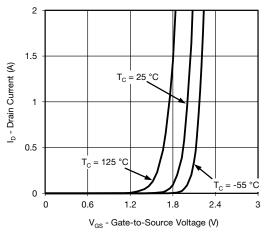
Gate Source Voltage vs. Gate Current



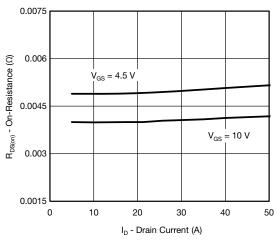
Gate Source Voltage vs. Gate Current

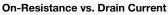


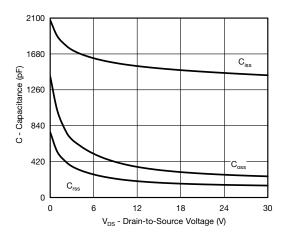
Output Characteristics



Transfer Characteristics

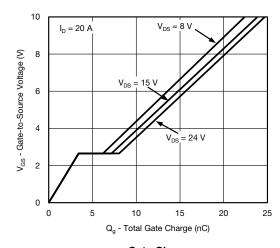




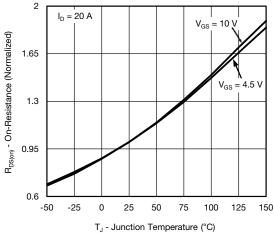


Capacitance

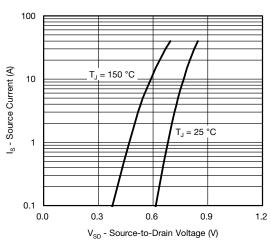




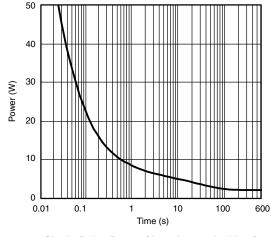
Gate Charge



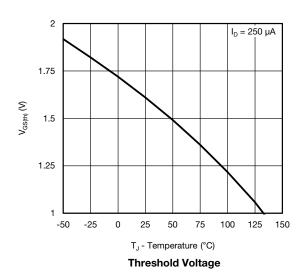
On-Resistance vs. Junction Temperature

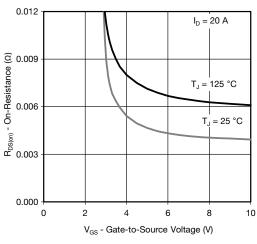


Source-Drain Diode Forward Voltage



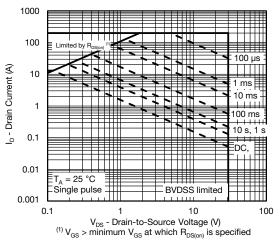
Single Pulse Power (Junction-to-Ambient)



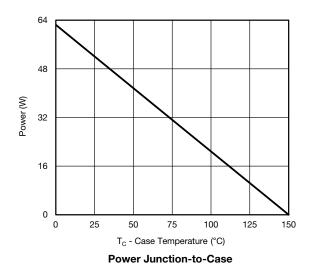


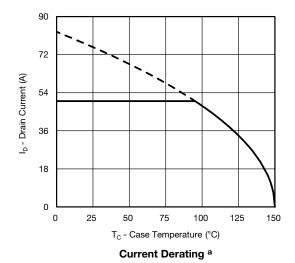
On-Resistance vs. Gate-to-Source Voltage





Safe Operating Area, Junction-to-Ambient

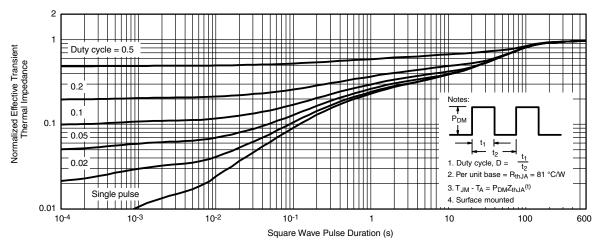




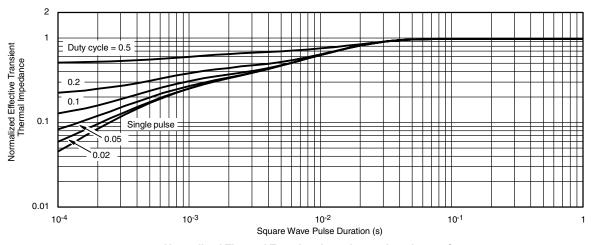
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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